

Continuum Stress Intensity Factors from Atomistic Fracture Simulations



MRS Spring Meeting 2019

Mathematical Aspects of Materials Science – Modeling,
Analysis and Computations

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PRESENTED BY

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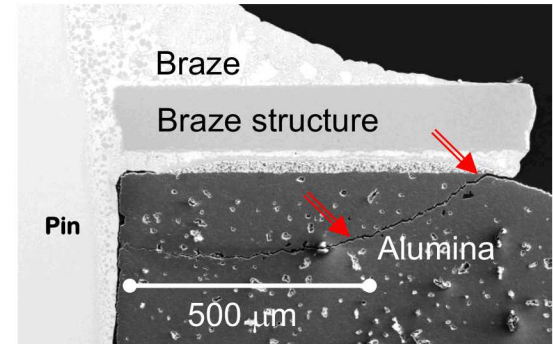
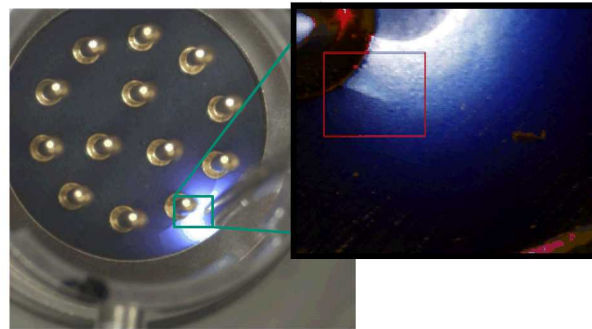


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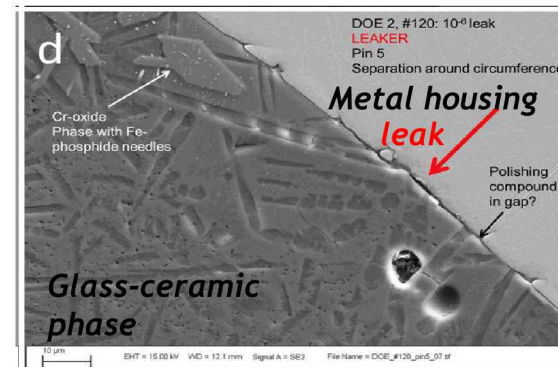
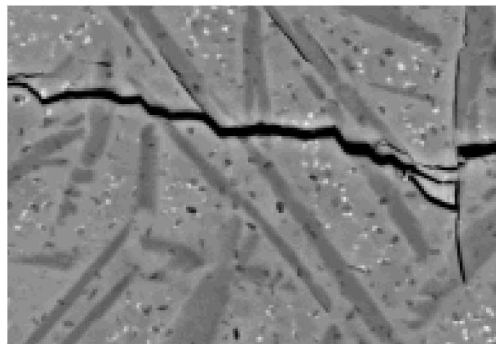
Motivation: Failure in brittle materials



Glass to metal seals



Brazed connections

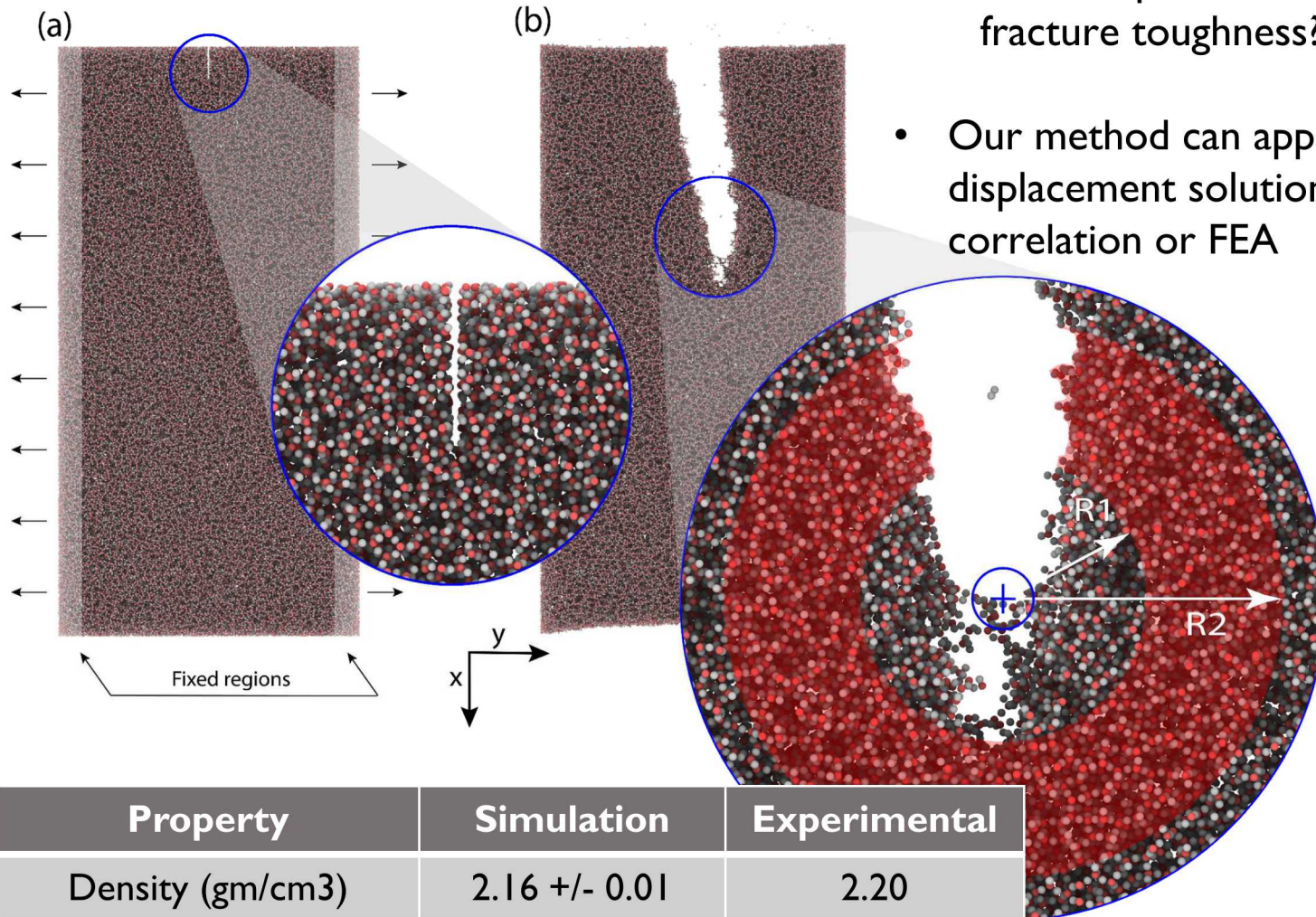


Glass-ceramics

Sandia interest: Brittle materials often fail from fracture during typical use and **environmental exposure**.

Challenge: Make 30 year lifespan reliability predictions for components containing brittle materials

3 Atomistic fracture simulations



Question:

What impact does chemistry have on fracture toughness?

- Our method can apply to any full-field displacement solution, e.g. digital image correlation or FEA

Property	Simulation	Experimental
Density (gm/cm ³)	2.16 +/- 0.01	2.20
Young's modulus (GPa)	77.90 +/- 2.02	72.9
Shear modulus (GPa)	25.81 +/- 0.95	31.3
Poisson ratio	0.250 +/- 0.005	0.165

- ~60 X 30 X 5 nm
- ReaxFF potential
- ~400K atoms
- 540 processes
- ~30 day computational time

Williams expansion – LEFM fields

$$u(r, \theta) = \sum_{n=0}^{\infty} \sum_{m=1}^2 A_m^n f_m^n(r, \theta)$$

$$= \sum_{n=0}^{\infty} A_1^n \frac{r^{n/2}}{2\mu} \left[\left(\kappa + \frac{n}{2} + (-1)^n \right) \cos \frac{n}{2} \theta - \frac{n}{2} \cos \left(\frac{n}{2} - 2 \right) \theta \right] +$$

$$\sum_{n=0}^{\infty} A_2^n \frac{r^{n/2}}{2\mu} \left[\left(-\kappa - \frac{n}{2} + (-1)^n \right) \sin \frac{n}{2} \theta + \frac{n}{2} \sin \left(\frac{n}{2} - 2 \right) \theta \right]$$

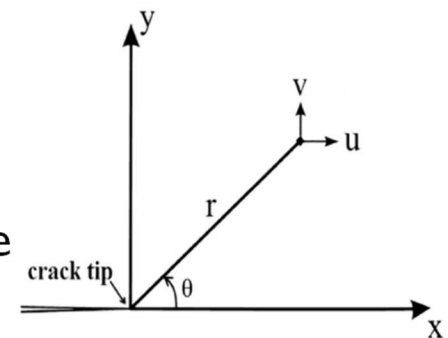
$$v(r, \theta) = \sum_{n=0}^{\infty} \sum_{m=1}^2 A_m^n g_m^n(r, \theta)$$

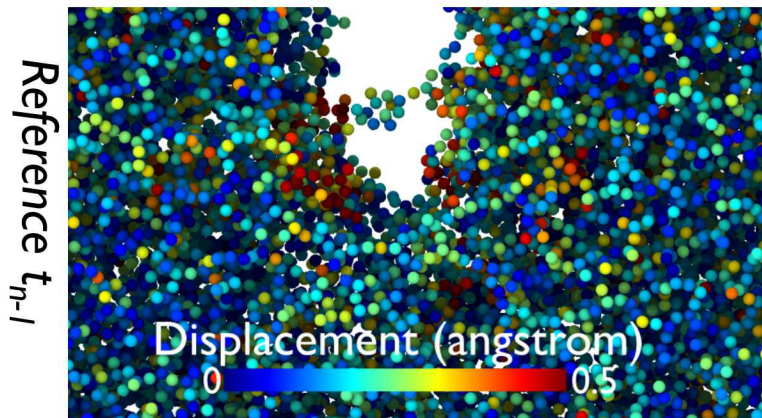
$$= \sum_{n=0}^{\infty} A_1^n \frac{r^{n/2}}{2\mu} \left[\left(\kappa - \frac{n}{2} - (-1)^n \right) \sin \frac{n}{2} \theta + \frac{n}{2} \sin \left(\frac{n}{2} - 2 \right) \theta \right] +$$

$$\sum_{n=0}^{\infty} A_2^n \frac{r^{n/2}}{2\mu} \left[\left(\kappa - \frac{n}{2} + (-1)^n \right) \cos \frac{n}{2} \theta + \frac{n}{2} \cos \left(\frac{n}{2} - 2 \right) \theta \right]$$

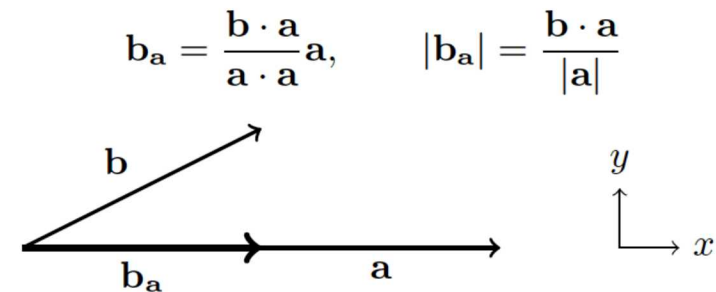
$$K_I = \sqrt[3]{2\pi A_1^1} \quad K_{II} = -\sqrt[3]{2\pi A_2^1} \quad T = 4A_1^2$$

- Solutions to the Airy stress function, in terms of displacements
- Any given observed discrete displacement about a crack tip can be described in terms of the Williams expansion





- Project noisy data into the continuous space of the Williams expansion



$$\mathbf{u}_m^n(r, \theta) = f_m^n(r, \theta) \hat{\mathbf{e}}_1 + g_m^n(r, \theta) \hat{\mathbf{e}}_2$$

$$\mathbf{u}^{\text{OBS}}(r, \theta) \approx \sum_{m,n} A_m^n \mathbf{u}_m^n(r, \theta)$$

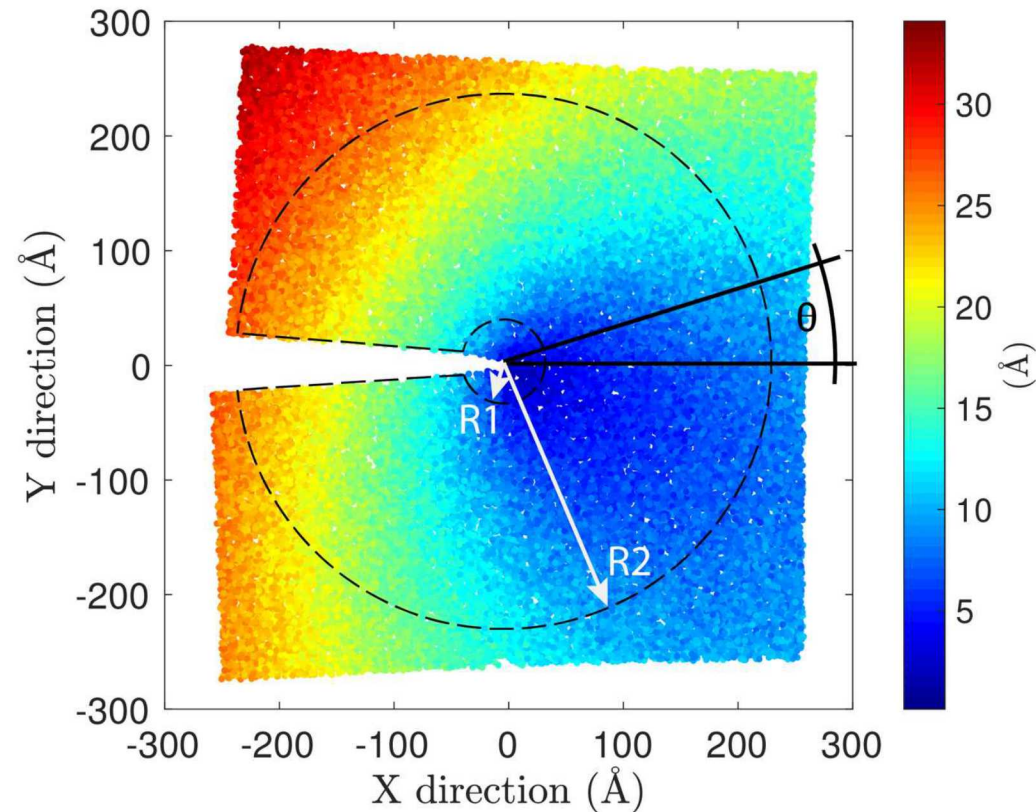
$$\langle \mathbf{u}_c^d, \mathbf{u}^{\text{OBS}} \rangle = \langle \mathbf{u}_c^d, \mathbf{u}_m^n \rangle A_m^n$$

$$\mathbf{b}_m^n = \mathbf{S}_{c,m}^{d,n} A_m^n$$

- Define a vector displacement function
- Observed displacements can be defined in terms of the Williams expansion
- Project the continuous Williams functions from the left
- Considering all $\{m,n\}$ combination, this results in a linear system of equations

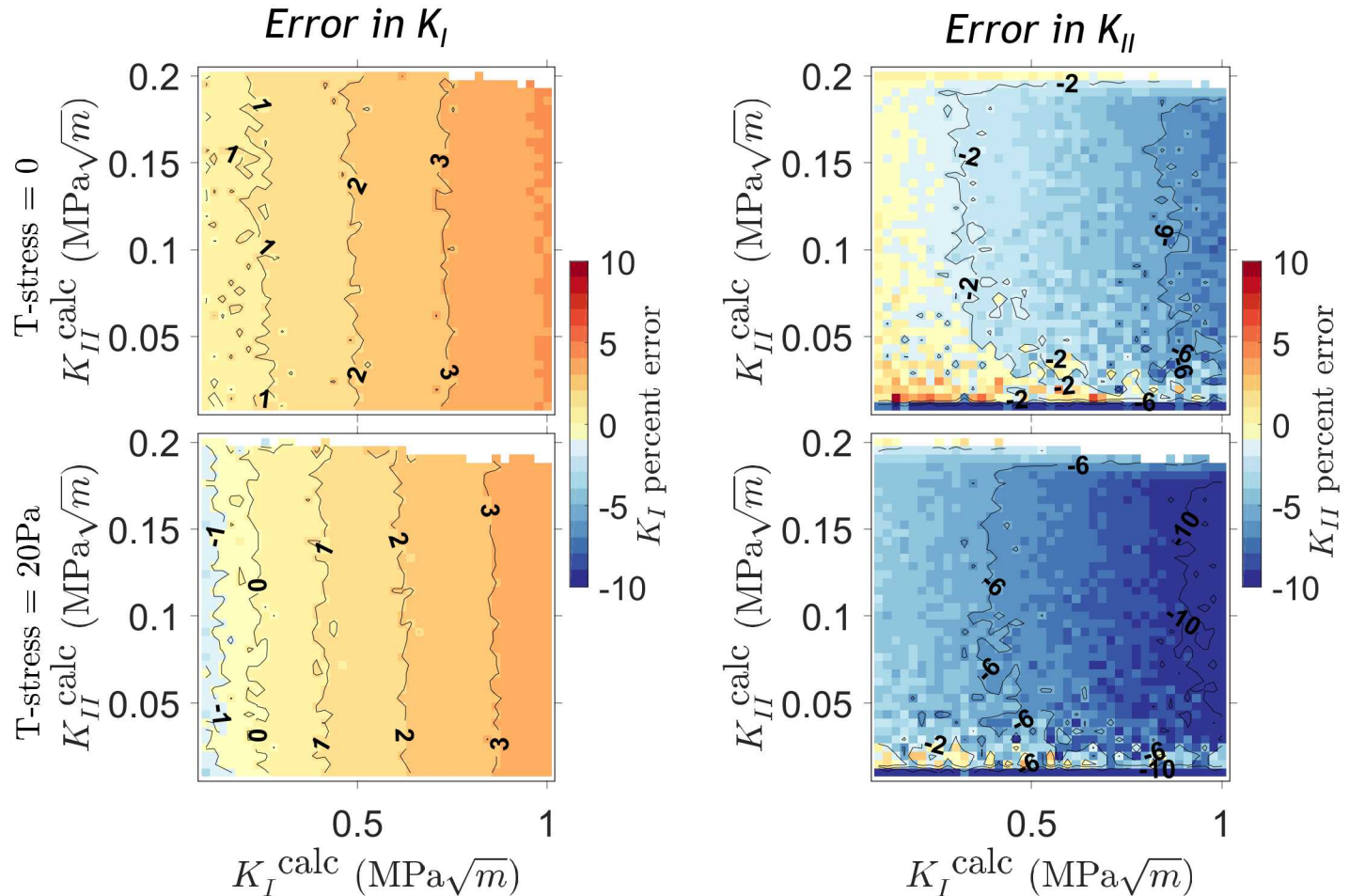
$$K_I = \sqrt[3]{2\pi A_1^1} \quad K_{II} = -\sqrt[3]{2\pi A_2^1} \quad T = 4A_1^2$$

- Use a simple “toy” model to demonstrate the technique
- Apply a combination of K_I , K_{II} , and T-stress fields and add Gaussian distributed noise
- The best case scenario in that,
 - crack tip location is known
 - applied field is known
 - no blunting of the crack tip



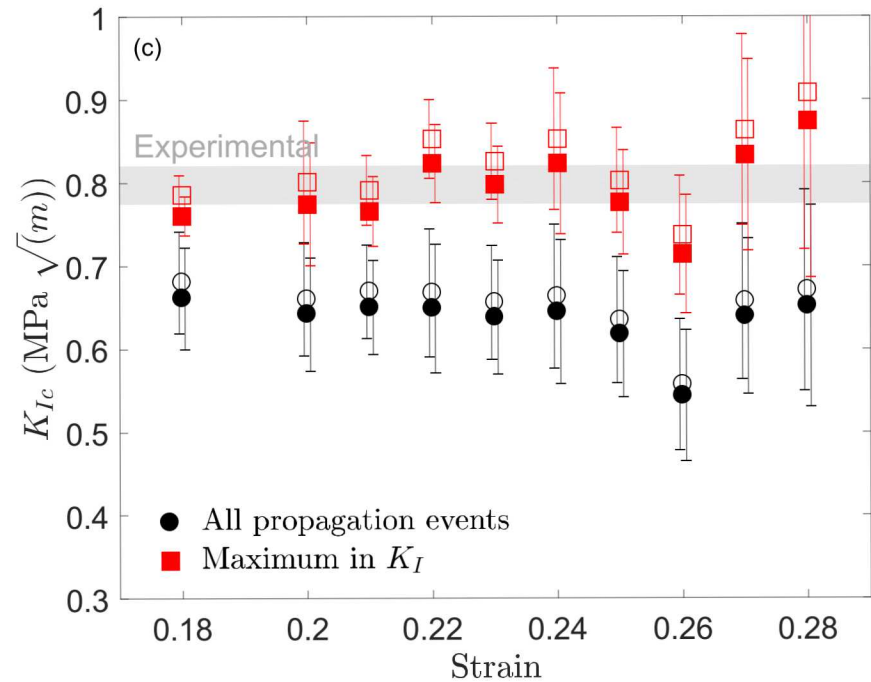
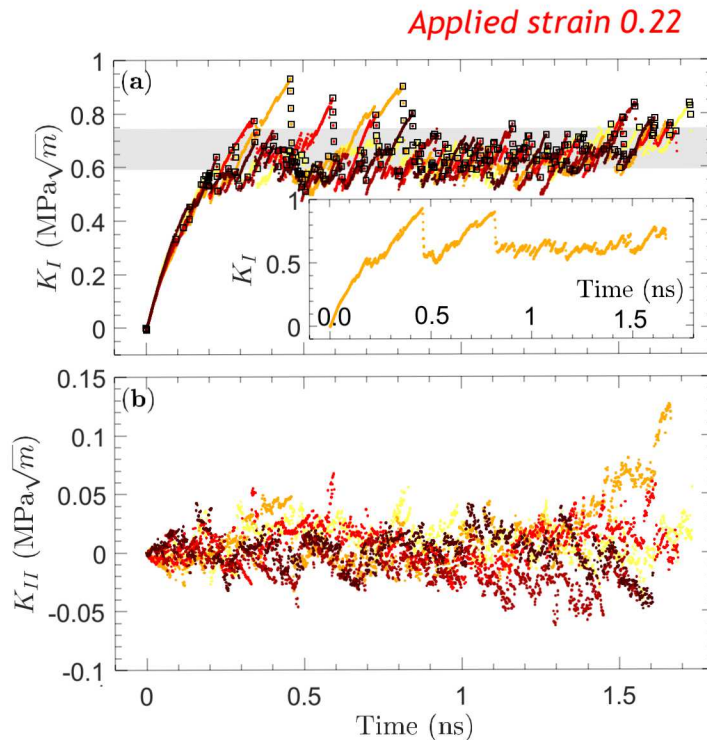
	K_I	K_{II}	T-stress
Applied	0.70	0.10	0.00
Calculated	0.713	0.108	0.00088
% error	1.86	8.34	--

7 Numerical method sensitivity and errors

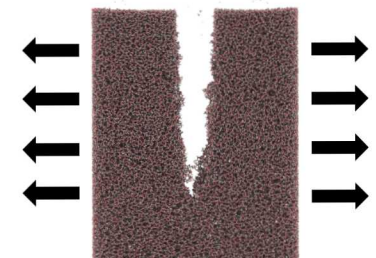


- Toy model is computationally fast and can be run hundreds of times over a range of applied fields
- Systematic errors are identified and can be utilized to estimate expected error in systems where the applied field is unknown

8 Method applied to MD fracture

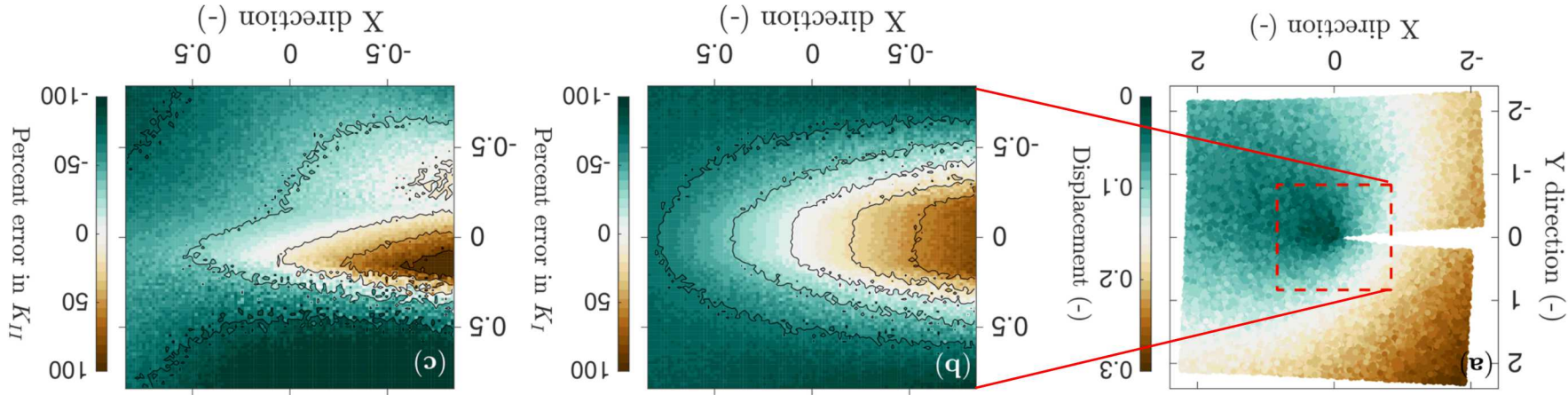


- Plateau region is representative of K_{IC}
- Systematic error in measurement can be assessed from the last slide: $\sim 2\%$
- Significant strain magnitudes are due to characteristic length scale of fracture



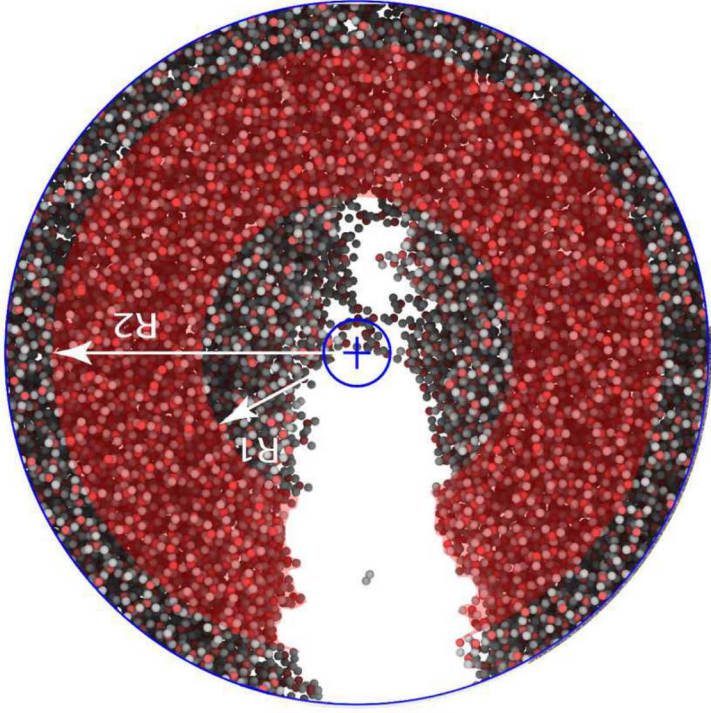
Held in constant strain

Misidentification of the crack tip



- Misidentification of the crack tip location can be important when applying the method to molecular dynamics

- Cause of possible errors:
 - Bridging Si-O chains
 - Crack tip blunting



Numerically locating the “true” crack tip

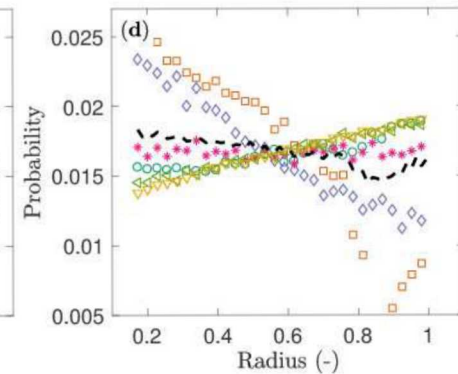
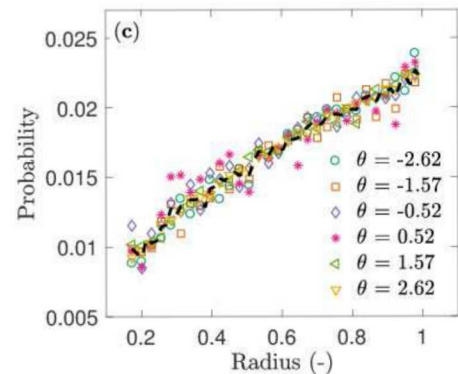
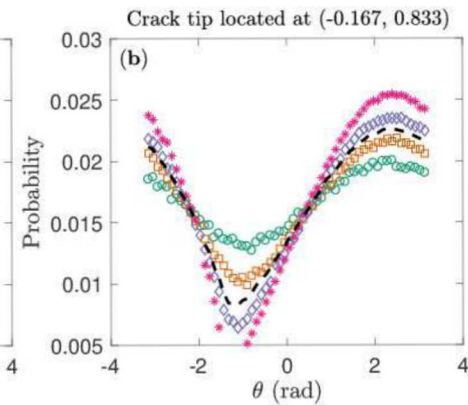
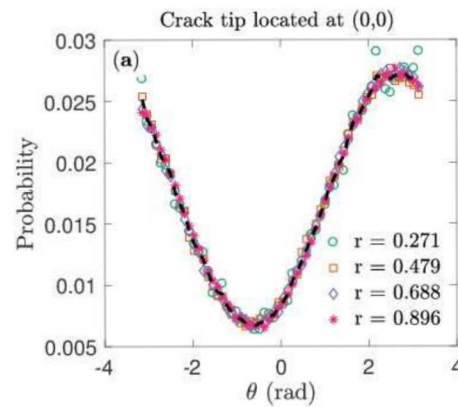
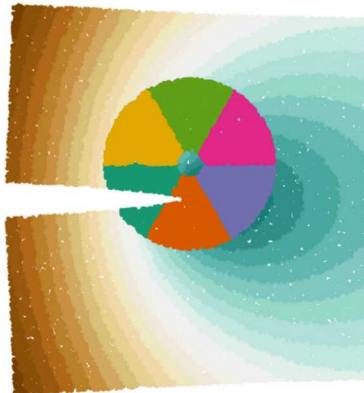
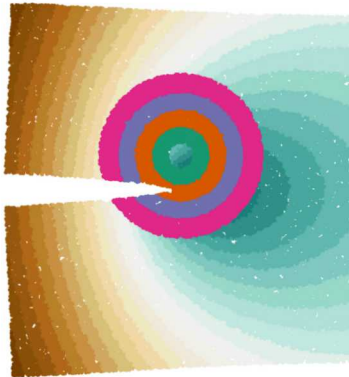
- We exploit the separability of the LEFM fields to identify the crack tip location
- A cost function can then be minimized to find spatial location

$$u(r, \theta) = \sum_{n=0}^{\infty} A \frac{r^{n/2}}{\mu} f(\theta)$$

$$\Phi^R(x, y) = \frac{1}{N} \sum_{j=1}^N \|P_j^R(r, \theta) - \bar{P}_j^R(r, \theta)\|_2$$

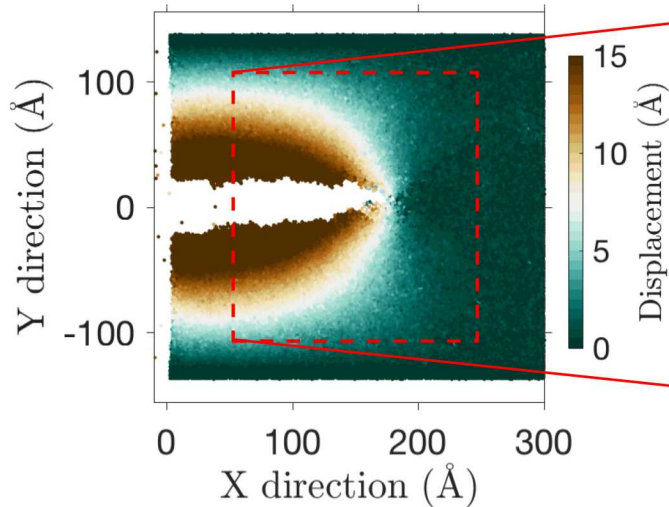
$$\Phi^\theta(x, y) = \frac{1}{N} \sum_{j=1}^N \|P_j^\theta(r, \theta) - \bar{P}_j^\theta(r, \theta)\|_2$$

$$\Phi(x, y) = \Phi^R(x, y) \cdot \Phi^\theta(x, y)$$

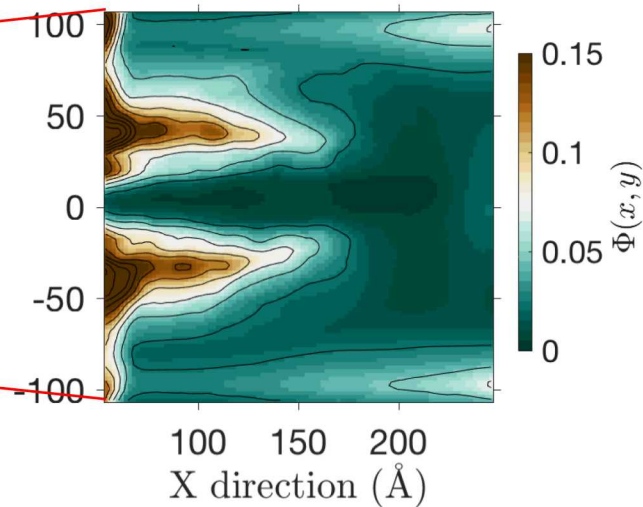


Applying method to molecular dynamics

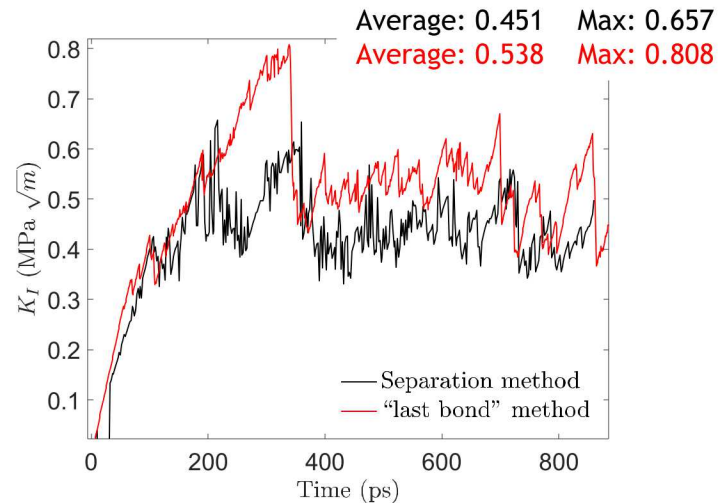
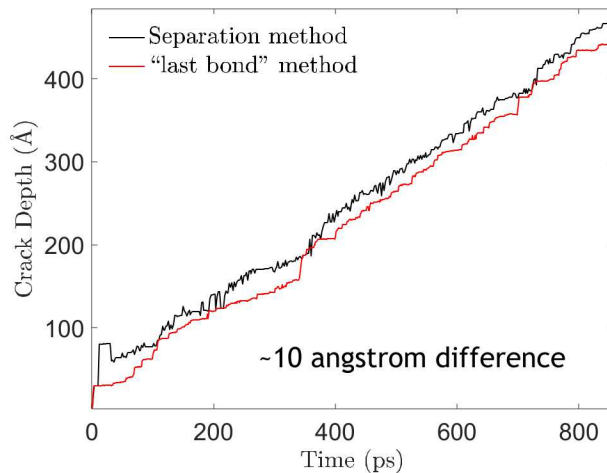
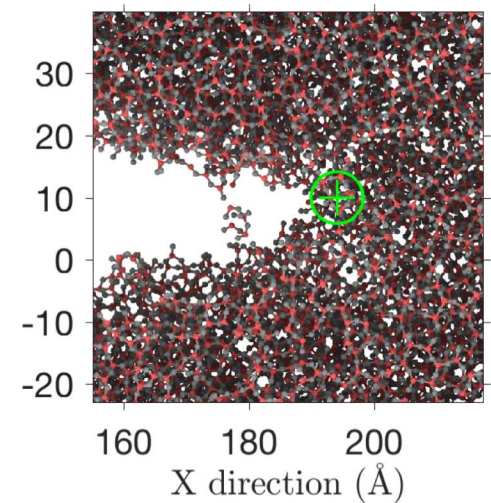
Displacement



Cost function



Atomic



- Developed a novel computational method to determine fracture toughness from atomistic MD simulations. Results for silica glass agree with experiment
- Method maintains chemical specificity and microstructural content
- Showed that correctly identifying the crack tip location is a necessity for accuracy
- **Impact:** Developed the capability to study the atomic origins of intrinsic material properties; important for understanding influence of chemistry on fracture toughness and impact of corrosive agents

Thank you for your time and attention!

Extra slides

Numerical method sensitivity and errors

